

## **UGET CEE**

Device carrier, CEE socket

UGET CEE components are device carriers from the underfloor system range. They contain a CEE socket and, instead of a mounting box, can be inserted into the corresponding snap-in ladders using the integrated fastening clamps and then snapped into the centre of the installation units. The device carriers are made of sendzimir hot-dip galvanised sheet steel, with the socket housing in light grey and the cover in red. It is advisable to use an angled plug for assembly.



steel, continously hot galvanized/Sendzimir process

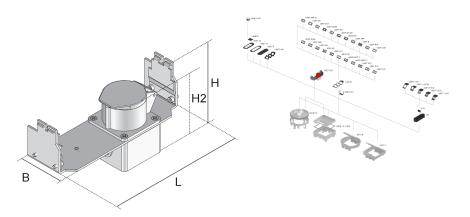
Products	Н	H <sub>min</sub>	В	L		weight
					16 A (3-polig + N + PE)	0,850 kg
					32 A (3-polig + N + PE)	0,931 kg

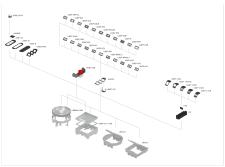
H: height

H<sub>min</sub>: minimum installation height

**B**: width **L**: length

## **DETAIL AND APPLICATION IMAGES**





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## PRODUCT INFORMATION

## **OPTIONAL ACCESSORIES**

**UGEARL** 



Load requirements according to, DIN EN 50085





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